IPC ASSOCIATION CON ELECTRONICS IND	Material Comp © Copyright 2005. I oustraies international and Par	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This docu	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					nformation	1		
upplier In	formation													
Company name* Company unique I				ique ID	ue ID Unique ID A		ID Authority Re			Response D	Response Date*			
nsemi							!				2024-04-26			
Contact Name T				Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-	Stewards		Product Envi	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
uthorized Re	epresentative*		Title - Repre	Title - Representative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com					
Re	Requester Item Number		Mfr Item Number Mfr Item Name			Effective Dat	e Version	n I	Manufacturing Site	Wei	ght*	UOM	Unit Type	
		NXH10 TG	00B120H3Q0P	PIM 60-80kW Q0E (Press-fit Pin, TIM	Boost-L57 1200V, 100A	2024-04-26		(	CNG	2230	53.572	mg	Each	
Ianufactu	ring Proccess Informa	tion												
Teri	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD-020 MS		STD-020 MSL Rating	Peak Process Body Temperature Max Time at Pea			k Temperature Number of Reflow Cycles					
Matte Tin (Sn) - annealed		CU Alloy NA		A	0 C 30		30	seconds 3						

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a								
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier shave provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	10240.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		3584	mg
			Supplier	PBT	26062-94-2		6656	mg
DBC	6550.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		2620	mg
			Supplier	Copper (Cu)	7440-50-8		3930.0002	mg
Die	83.5719	mg	Supplier	Silicon Carbide	409-21-2		83.5719	mg
			Supplier	Silicon (Si)	7440-21-3		0	mg
Glue	60.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		6	mg
			Supplier	Miscellaneous	Trade Secret		6	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		48	mg
NTC	10.0	mg	Supplier	Silver (Ag)	7440-22-4		0.0979	mg
			Supplier	Tin (Sn)	7440-31-5		0.02	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		3.9169	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0999	mg
			В	Nickel (Ni)	7440-02-0		0.01	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.3997	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		5.4556	mg
Silicone Gel	2700.0	mg	Supplier	Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified	68988-89-6		810.0001	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		1890	mg
Solder Paste	210.0	mg	Supplier	Silver (Ag)	7440-22-4		7.35	mg
			Supplier	Tin (Sn)	7440-31-5		202.65	mg
Terminal	2430.0	mg	Supplier	Silicon (Si)	7440-21-3		6.561	mg
			В	Nickel (Ni)	7440-02-0		32.805	mg
			Supplier	Copper (Cu)	7440-50-8		2390.0266	mg
			Supplier	Phosphorus (P)	7723-14-0		0.6075	mg
Wire Bond - Al	80.0	mg	Supplier	Aluminum (Al)	7429-90-5		80	mg